

APPLICATION DATA SHEET**Application Information**

Application Number::

Filing Date:: October 17, 2005

Application Type:: Regular

Subject Matter:: Utility

Suggested Classification::

Suggested Group Art Unit::

CD-ROM or CD-R:: None

Number of CD Disks::

Number of Copies of CDs::

Sequence Submission?:: No

Computer Readable Form (CRF)?:: No

Number of Copies of CRF::

Title : MONITORING THE REDUCTION IN
THICKNESS AS MATERIAL IS REMOVED
FROM A WAFER COMPOSITE AND TEST
STRUCTURE FOR MONITORING REMOVAL
OF MATERIAL

Attorney Docket Number:: 60291.000041

Request for Early Publication?:: No

Request for Non-Publication?:: No

Suggested Drawing Figure:: 1

Total Drawing Sheets:: 1

Small Entity?:: No

Latin name::

Variety denomination name::

Petition Included?:: No

Petition Type::

Licensed US Government Agency::

Contract or Grant Numbers::

Secrecy Order in Parent Application?:: No

Applicant Information

Applicant One Authority Type:: Inventor
Primary Citizenship Germany
Country::
Status:: Full Capacity

Applicant One Given Name:: Ralf
Middle Name::
Family Name:: LERNER
Name Suffix::
City of Residence:: Erfurt
State or Province of Residence::
Country of Residence:: Germany
Street of Mailing Address:: Josef-Albers-Strasse 20
City of Mailing Address:: Erfurt
State or Province of Mailing Address::
Country of Mailing Address:: Germany
Postal or Zip Code of Mailing Address:: 99085

Correspondence Information

Correspondence Customer No.: 21967
Name:: Hunton & Williams LLP
Street of Mailing Address:: 1900 K Street, N.W.
City of Mailing Address: Washington, DC
State or Province of Mailing Address::
Country of Mailing Address:: USA
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Representative Information

Representative Customer Number:: 21967

International Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	Claims priority to	PCT/DE2004/000801	16 April 2004

Foreign Priority Information

Country:	Application Number::	Filing Date::	Priority Claimed::
Germany	103 17 747.7	17 April 2003	Yes

Assignee Information

Assignee Name:: X-FAB SEMICONDUCTOR FOUNDRIES AG.
Street of Mailing Address :: Haarbergstrasse 67
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State of Province of Mailing Address::
Country of Mailing Address:: Germany
Postal or Zip Code of Mailing Address:: 99085